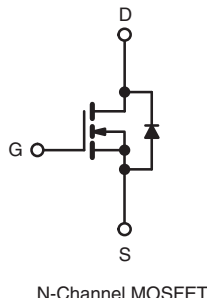
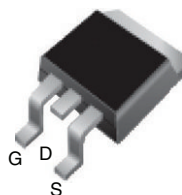


## E Series Power MOSFET

### PRODUCT SUMMARY

|                                         |                 |      |
|-----------------------------------------|-----------------|------|
| $V_{DS}$ (V) at $T_J$ max.              | 700             |      |
| $R_{DS(on)}$ max. at 25 °C ( $\Omega$ ) | $V_{GS} = 10$ V | 0.28 |
| $Q_g$ max. (nC)                         | 96              |      |
| $Q_{gs}$ (nC)                           | 11              |      |
| $Q_{gd}$ (nC)                           | 21              |      |
| Configuration                           | Single          |      |

**D<sup>2</sup>PAK (TO-263)**


### FEATURES

- Low figure-of-merit (FOM)  $R_{on} \times Q_g$
- Low input capacitance ( $C_{iss}$ )
- Reduced switching and conduction losses
- Ultra low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

### ORDERING INFORMATION

|                                 |                             |
|---------------------------------|-----------------------------|
| Package                         | D <sup>2</sup> PAK (TO-263) |
| Lead (Pb)-free and Halogen-free | SiHB15N65E-GE3              |

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)

| PARAMETER                                                 | SYMBOL           | LIMIT          | UNIT |
|-----------------------------------------------------------|------------------|----------------|------|
| Drain-Source Voltage                                      | $V_{DS}$         | 650            | V    |
| Gate-Source Voltage                                       | $V_{GS}$         | $\pm 30$       |      |
| Continuous Drain Current ( $T_J = 150$ °C)                | $V_{GS}$ at 10 V | $T_C = 25$ °C  | A    |
|                                                           |                  | $T_C = 100$ °C |      |
| Pulsed Drain Current <sup>a</sup>                         | $I_{DM}$         | 38             |      |
| Linear Derating Factor                                    |                  | 1.4            | W/°C |
| Single Pulse Avalanche Energy <sup>b</sup>                | $E_{AS}$         | 286            | mJ   |
| Maximum Power Dissipation                                 | $P_D$            | 34             | W    |
| Operating Junction and Storage Temperature Range          | $T_J, T_{stg}$   | -55 to +150    | °C   |
| Drain-Source Voltage Slope                                | $dV/dt$          | 37             | V/ns |
| Reverse Diode $dV/dt$ <sup>d</sup>                        |                  | 23             |      |
| Soldering Recommendations (Peak Temperature) <sup>c</sup> |                  | 300            | °C   |

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 50$  V, starting  $T_J = 25$  °C,  $L = 28.2$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 4.5$  A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$ ,  $dI/dt = 100$  A/ $\mu$ s, starting  $T_J = 25$  °C.

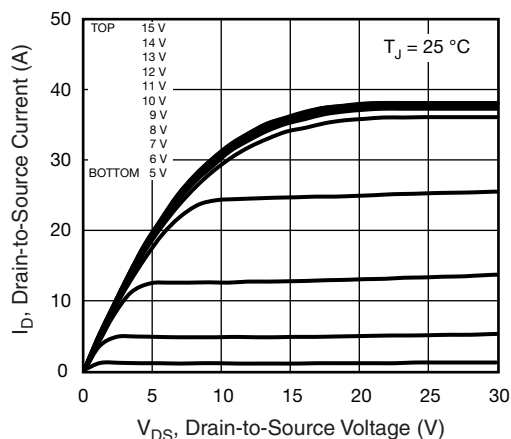
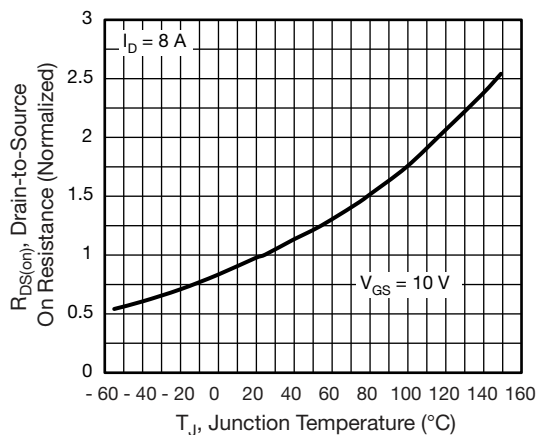
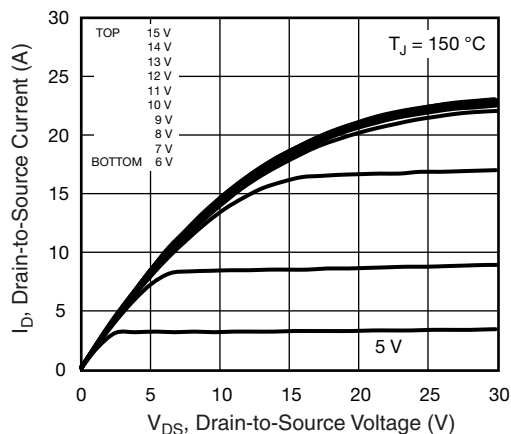
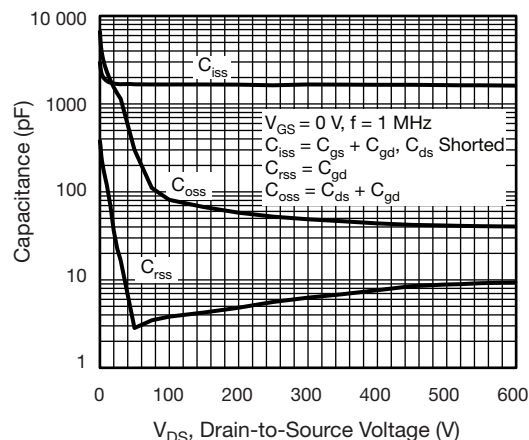
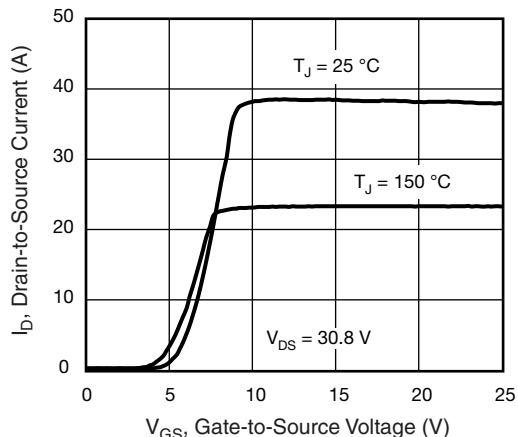
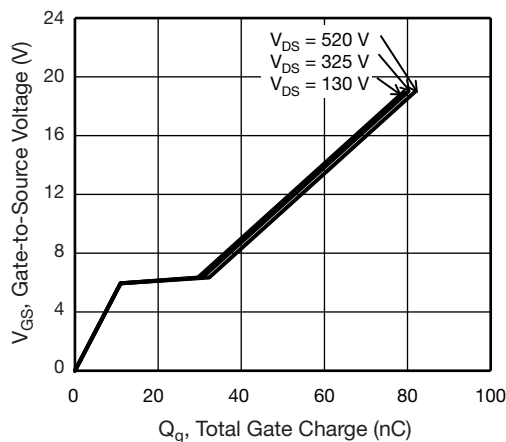
### THERMAL RESISTANCE RATINGS

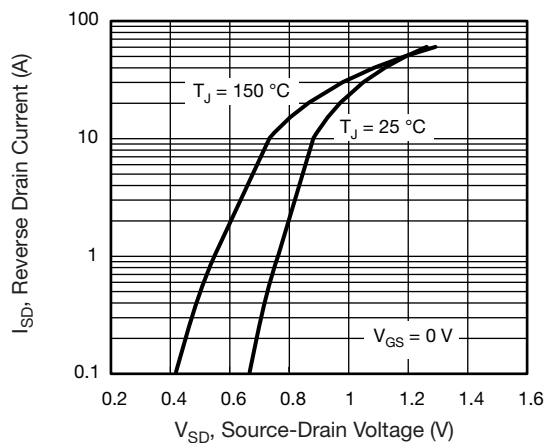
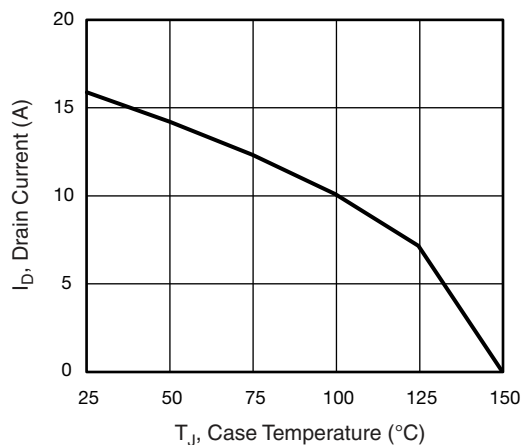
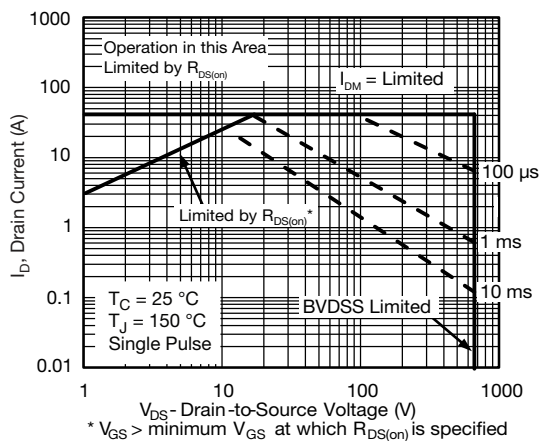
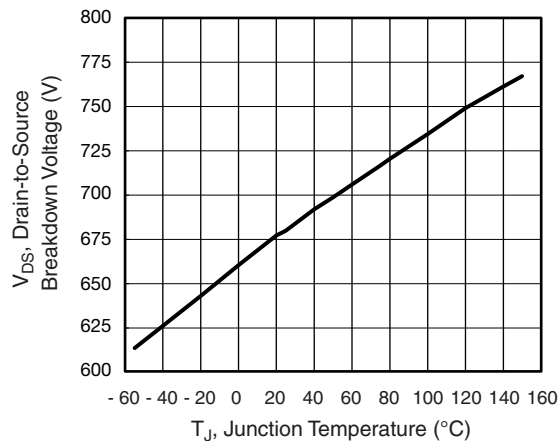
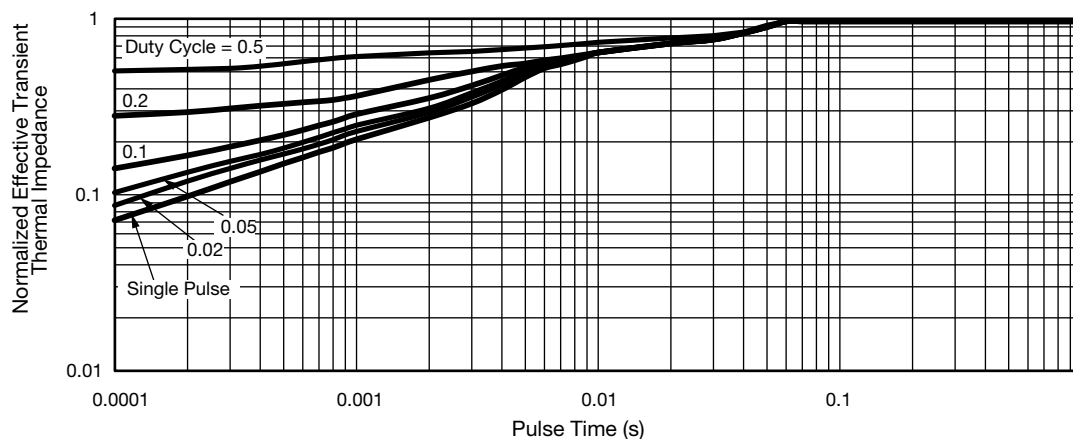
| PARAMETER                        | SYMBOL     | TYP. | MAX. | UNIT |
|----------------------------------|------------|------|------|------|
| Maximum Junction-to-Ambient      | $R_{thJA}$ | -    | 62   | °C/W |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | -    | 0.7  |      |

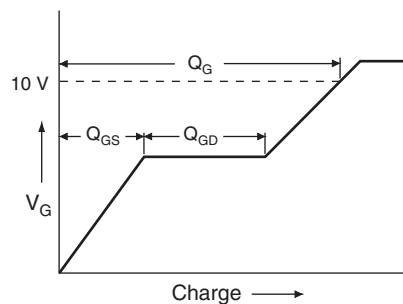
| <b>SPECIFICATIONS</b> ( $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted) |                     |                                                                                                                                                          |      |      |           |                       |
|--------------------------------------------------------------------------------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|-----------|-----------------------|
| PARAMETER                                                                            | SYMBOL              | TEST CONDITIONS                                                                                                                                          | MIN. | TYP. | MAX.      | UNIT                  |
| <b>Static</b>                                                                        |                     |                                                                                                                                                          |      |      |           |                       |
| Drain-Source Breakdown Voltage                                                       | $V_{DS}$            | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                   | 650  | -    | -         | V                     |
| $V_{DS}$ Temperature Coefficient                                                     | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^{\circ}\text{C}$ , $I_D = 1\text{ mA}$                                                                                          | -    | 0.75 | -         | V/ $^{\circ}\text{C}$ |
| Gate-Source Threshold Voltage (N)                                                    | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                       | 2    | -    | 4         | V                     |
| Gate-Source Leakage                                                                  | $I_{GSS}$           | $V_{GS} = \pm 20\text{ V}$                                                                                                                               | -    | -    | $\pm 100$ | nA                    |
|                                                                                      |                     | $V_{GS} = \pm 30\text{ V}$                                                                                                                               | -    | -    | $\pm 1$   | $\mu\text{A}$         |
| Zero Gate Voltage Drain Current                                                      | $I_{DSS}$           | $V_{DS} = 650\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                                          | -    | -    | 1         | $\mu\text{A}$         |
|                                                                                      |                     | $V_{DS} = 520\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$                                                                    | -    | -    | 10        |                       |
| Drain-Source On-State Resistance                                                     | $R_{DS(on)}$        | $V_{GS} = 10\text{ V}$ , $I_D = 8\text{ A}$                                                                                                              | -    | 0.23 | 0.28      | $\Omega$              |
| Forward Transconductance                                                             | $g_{fs}$            | $V_{DS} = 30\text{ V}$ , $I_D = 8\text{ A}$                                                                                                              | -    | 5.6  | -         | S                     |
| <b>Dynamic</b>                                                                       |                     |                                                                                                                                                          |      |      |           |                       |
| Input Capacitance                                                                    | $C_{iss}$           | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = 100\text{ V}$ ,<br>$f = 1\text{ MHz}$                                                                               | -    | 1640 | -         | pF                    |
| Output Capacitance                                                                   | $C_{oss}$           |                                                                                                                                                          | -    | 80   | -         |                       |
| Reverse Transfer Capacitance                                                         | $C_{rss}$           |                                                                                                                                                          | -    | 4    | -         |                       |
| Effective Output Capacitance, Energy Related <sup>a</sup>                            | $C_{o(er)}$         | $V_{DS} = 0\text{ V to } 520\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                           | -    | 63   | -         |                       |
| Effective Output Capacitance, Time Related <sup>b</sup>                              | $C_{o(tr)}$         |                                                                                                                                                          | -    | 213  | -         |                       |
| Total Gate Charge                                                                    | $Q_g$               | $V_{GS} = 10\text{ V}$ , $I_D = 8\text{ A}$ , $V_{DS} = 520\text{ V}$                                                                                    | -    | 48   | 96        | nC                    |
| Gate-Source Charge                                                                   | $Q_{gs}$            |                                                                                                                                                          | -    | 11   | -         |                       |
| Gate-Drain Charge                                                                    | $Q_{gd}$            |                                                                                                                                                          | -    | 21   | -         |                       |
| Turn-On Delay Time                                                                   | $t_{d(on)}$         | $V_{DD} = 520\text{ V}$ , $I_D = 8\text{ A}$ ,<br>$V_{GS} = 10\text{ V}$ , $R_g = 9.1\text{ }\Omega$                                                     | -    | 18   | 36        | ns                    |
| Rise Time                                                                            | $t_r$               |                                                                                                                                                          | -    | 24   | 48        |                       |
| Turn-Off Delay Time                                                                  | $t_{d(off)}$        |                                                                                                                                                          | -    | 48   | 96        |                       |
| Fall Time                                                                            | $t_f$               |                                                                                                                                                          | -    | 25   | 50        |                       |
| Gate Input Resistance                                                                | $R_g$               | $f = 1\text{ MHz}$ , open drain                                                                                                                          | -    | 0.8  | -         | $\Omega$              |
| <b>Drain-Source Body Diode Characteristics</b>                                       |                     |                                                                                                                                                          |      |      |           |                       |
| Continuous Source-Drain Diode Current                                                | $I_S$               | MOSFET symbol showing the integral reverse p - n junction diode<br> | -    | -    | 15        | A                     |
| Pulsed Diode Forward Current                                                         | $I_{SM}$            |                                                                                                                                                          | -    | -    | 38        |                       |
| Diode Forward Voltage                                                                | $V_{SD}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_S = 8\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                          | -    | -    | 1.2       | V                     |
| Reverse Recovery Time                                                                | $t_{rr}$            | $T_J = 25\text{ }^{\circ}\text{C}$ , $I_F = I_S = 8\text{ A}$ ,<br>$dI/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 400\text{ V}$                             | -    | 325  | -         | ns                    |
| Reverse Recovery Charge                                                              | $Q_{rr}$            |                                                                                                                                                          | -    | 4.6  | -         | $\mu\text{C}$         |
| Reverse Recovery Current                                                             | $I_{RRM}$           |                                                                                                                                                          | -    | 20   | -         | A                     |

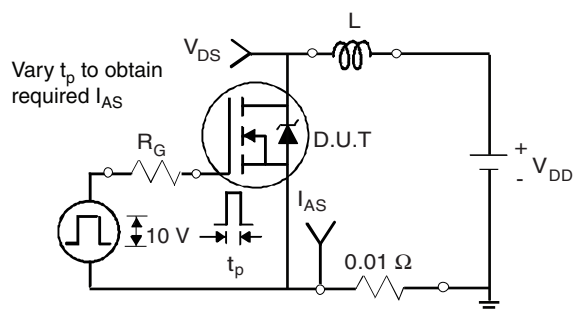
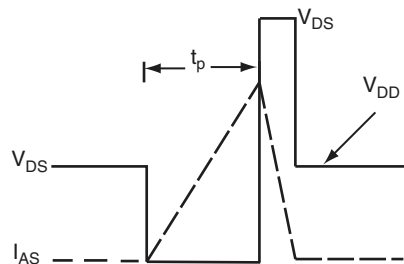
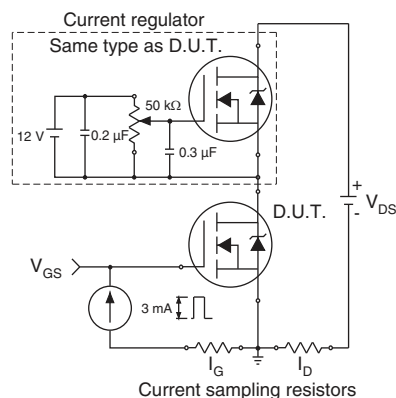
**Notes**

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .  
b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**


**Fig. 7 - Typical Source-Drain Diode Forward Voltage**

**Fig. 9 - Maximum Drain Current vs. Case Temperature**

**Fig. 8 - Maximum Safe Operating Area**

**Fig. 10 - Temperature vs. Drain-to-Source Voltage**

**Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case**


**Fig. 12 - Switching Time Test Circuit**

**Fig. 16 - Basic Gate Charge Waveform**

**Fig. 13 - Switching Time Waveforms**

**Fig. 14 - Unclamped Inductive Test Circuit**

**Fig. 15 - Unclamped Inductive Waveforms**

**Fig. 17 - Gate Charge Test Circuit**


**Note**

a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 18 - For N-Channel**

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### TO-263AB (HIGH VOLTAGE)



| DIM. | MILLIMETERS |      | INCHES |       |
|------|-------------|------|--------|-------|
|      | MIN.        | MAX. | MIN.   | MAX.  |
| A    | 4.06        | 4.83 | 0.160  | 0.190 |
| A1   | 0.00        | 0.25 | 0.000  | 0.010 |
| b    | 0.51        | 0.99 | 0.020  | 0.039 |
| b1   | 0.51        | 0.89 | 0.020  | 0.035 |
| b2   | 1.14        | 1.78 | 0.045  | 0.070 |
| b3   | 1.14        | 1.73 | 0.045  | 0.068 |
| c    | 0.38        | 0.74 | 0.015  | 0.029 |
| c1   | 0.38        | 0.58 | 0.015  | 0.023 |
| c2   | 1.14        | 1.65 | 0.045  | 0.065 |
| D    | 8.38        | 9.65 | 0.330  | 0.380 |

| DIM. | MILLIMETERS |       | INCHES    |       |
|------|-------------|-------|-----------|-------|
|      | MIN.        | MAX.  | MIN.      | MAX.  |
| D1   | 6.86        | -     | 0.270     | -     |
| E    | 9.65        | 10.67 | 0.380     | 0.420 |
| E1   | 6.22        | -     | 0.245     | -     |
| e    | 2.54 BSC    |       | 0.100 BSC |       |
| H    | 14.61       | 15.88 | 0.575     | 0.625 |
| L    | 1.78        | 2.79  | 0.070     | 0.110 |
| L1   | -           | 1.65  | -         | 0.066 |
| L2   | -           | 1.78  | -         | 0.070 |
| L3   | 0.25 BSC    |       | 0.010 BSC |       |
| L4   | 4.78        | 5.28  | 0.188     | 0.208 |

ECN: S-82110-Rev. A, 15-Sep-08  
DWG: 5970

#### Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.
2. Dimensions are shown in millimeters (inches).
3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
5. Dimension b1 and c1 apply to base metal only.
6. Datum A and B to be determined at datum plane H.
7. Outline conforms to JEDEC outline to TO-263AB.

**RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads  
Dimensions in Inches/(mm)

[Return to Index](#)



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